

Vishay Siliconix

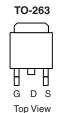
N-Channel 100-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	V_{DS} (V) $r_{DS(on)}$ (Ω)			
100	0.024 at V _{GS} = 10 V	47		
	0.027 at V _{GS} = 4.5 V	44		

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Maximum Junction Temperature
- 100 % Rg Tested





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N-Channel MOSFET

Ordering Information: SUM47N10-24L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS T_A =	25 °C, unless othe	rwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V _{GS}	± 20	- V	
	T _C = 25 °C		47	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	I _D	27	
Pulsed Drain Current	I _{DM}	70	А	
Continuous Source Current (Diode Conduction)	۱ _S	47		
Single Pulse Avalanche Current	I _{AS}	40		
Single Pulse Avalanche Energy (Duty Cycle \leq 1 %)	L = 0.1 mH	E _{AS}	80	mJ
Maximum Dawar Dissinction	T _C = 25 °C	P _D	136 ^b	w
Maximum Power Dissipation	T _A = 25 °C		3.75 ^a	VV
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Maximum	Unit		
Junction-to-Ambient	PCB Mount	P	40			
Sunction-to-Ambient	Free Air	– R _{thJA} –	62.5	°C/W		
Junction-to-Case	•	R _{thJC}	1.1			

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.

b. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static					<u> </u>		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		3.0		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V	1				
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μA	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 V, V_{GS} = 10 V$	70			А	
		V _{GS} = 10 V, I _D = 40 A	0.019		0.024		
		V_{GS} = 10 V, I _D = 40 A, T _J = 125 °C			0.048	Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = 10 V, I _D = 40 A, T _J = 175 °C			0.060		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.021	0.027		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 40 A		70		S	
Dynamic ^a							
Input Capacitance	C _{iss}			2400		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		290			
Reverse Transfer Capacitance	C _{rss}			120			
Total Gate Charge ^c	Qg			40	60		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 50 V, V_{GS} = 10 V, I_D = 40 A		11		nC	
Gate-Drain Charge ^c	Q _{gd}			9		1	
Gate Resistance	Rg	f = 1 MHz	1	2.2	3.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	13		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 1.25 Ω		40	60	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 47$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		15	25		
Fall Time ^c	t _f			80	120		
Source-Drain Diode Ratings and Cha	racteristics 7	_C = 25 °C					
Pulsed Current	I _{SM}				70	А	
Diode Forward Voltage ^b	V_{SD}	I _F = 40 A, V _{GS} = 0 V		1.0	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 47 A, di/dt = 100 A/μs		75	120	ns	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. Independent of operating temperature.

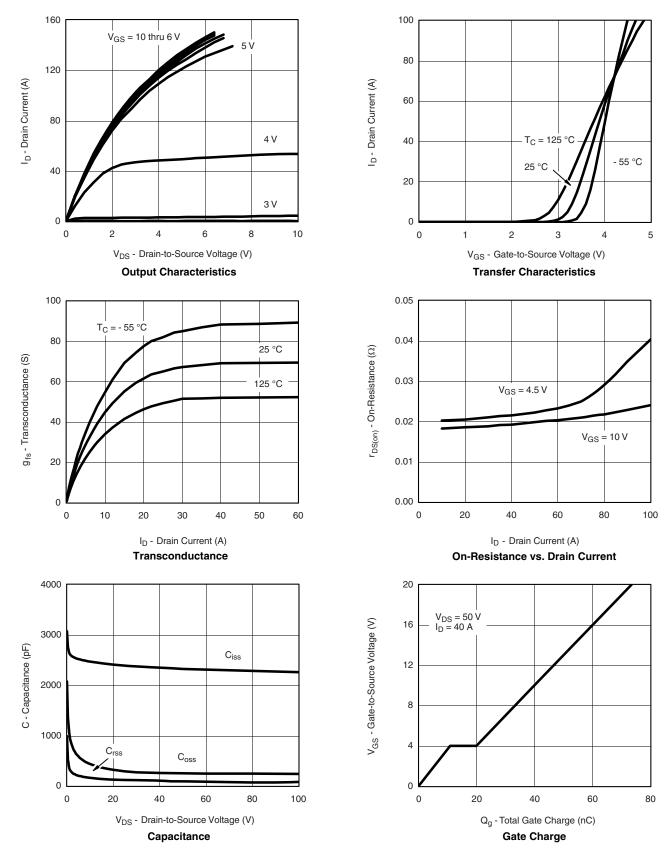
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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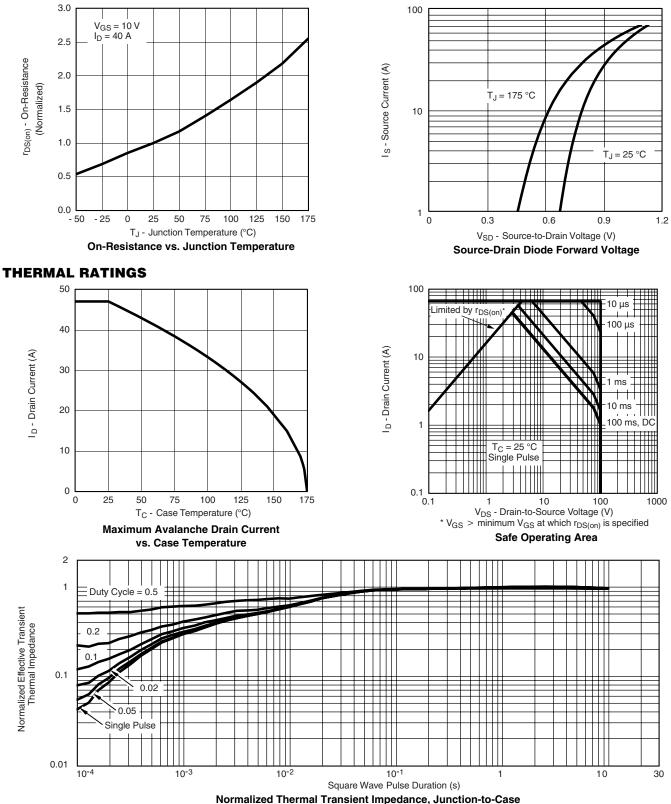




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72827.

/ISHA



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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
D1		0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
D4		0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
	К	0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254	BSC	
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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